g	GE	Energy	Functional Testing Specification
	Parts & Repair Services Louisville, KY		LOU-GED-IS200ECTBG1

# Test Procedure for an IS200ECTBG1xxx Card

REV.	DESCRIPTION	SIGNATURE	REV. DATE
Α	Initial release	J. Francis	1/4/2010
В	Updated test for use in EX2100 cabinet	D. Waddy	6/30/14
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PREPARED BY J. Francis	REVIEWED BY D. Waddy	REVIEWED BY	QUALITY APPROVAL Charlie Wade
DATE	DATE	DATE	DATE
1/4/2010	6/30/2014		1/7/2010

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#### 1. SCOPE

**1.1** This is a functional testing procedure for an IS200ECTBG1xxx.

### 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

#### 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - **3.1.1** Check board's electronic folder for more information

# 4. **ENGINEERING REQUIREMENTS**

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- **4.2** Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken, cracked, or loosely connected
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - 4.2.1.3 Components visually damaged
    - **4.2.1.4** Capacitors bloated or leaking
    - 4.2.1.5 Solder joints damaged or cold
    - 4.2.1.6 Circuit board burned or de-laminated
    - 4.2.1.7 Printed wire runs / Traces burned or damaged

### 5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	H190128	EX2100 cabinet
2		
3		

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### 6. TESTING PROCESS

## 6.1 Setup

6.1.1 Inspect customer card for any physical defects or issues before installing the customer card in the EX2100 cabinet. Once the card has been inspected <u>REMOVE</u>

<u>POWER FROM THE CABINET</u>. Locate the ECTB card on the back wall. Remove the test card and install the customer's card.

### 6.2 TESTING PROCEDURE

- **6.2.1** Apply power to the cabinet and go online with <u>TOOLBOX/EX2100/E1.dl.ecb</u>.
- **6.2.2** Clear all trips and alarms.
- 6.2.3 Turn switch 94 EX-1 and 94 EX-2 which should illuminate corresponding LED's above.
- 6.2.4 Verify that *GP relays* 1 through 4 are toggling between N/O and N/C. (these relays can also be verified by relays K1GP through K4GP, which have internal LED's that should also toggle)
- 6.2.5 Flip the 3-position toggle switches from *START* to *STOP* and *RAISE* to *LOWER* and verify with corresponding LED's. Toggle *GP Input 5*, *GP Input 6*, & *52G Closed* and verify with corresponding LED's. (these can also be verified by on board LED's on the ECTB)
- **6.2.6** Toggle **86 Trip** which should give a corresponding trip in toolbox, verify that the trip is present and that it clears.
- **6.2.7** Allow card to Burn-in for a minimum of 12 Hrs.
- 6.2.8 \*\*\*TEST COMPLETE

### 7. NOTES

**7.1** For troubleshooting purposes you may want to address archived procedure **LOU-GED-IS200ECTBG1-A**, for bench specific testing.

# 8. ATTACHMENTS

**8.1** None at this time.